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FPF2C8P2NL07A F2, 3-phase, 3-level NPC module with Press-fit / NTC

General Description

Fairchild's new inverter modules provide low conduction and switching loss as well. And Press-Fit technology provides simple and reliable mounting. These modules are optimized for the applications such as solar inverter and UPS where a high efficiency and robust design is needed.

Electrical Features

- High Efficiency
- Low Conduction and Switching Losses
- Field Stop IGBT for Inner and Outer Switch
- STEALTHTM Diode for Path Diode
- Built-in NTC for Temperature Monitoring

Mechanical Features

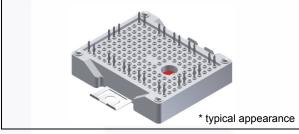
- Compact Size : F2 Package
- Press-fit Contact Technology
- Al₂O₃ Substrate with Low Thermal Resistance

Applications

- Solar Inverter
- UPS

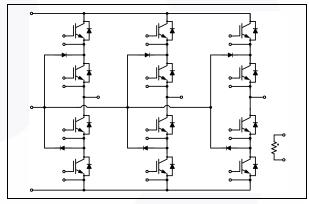
Related Materials

 AN-4167: Mounting Guideline for F1 / F2 Modules with Press-Fit Pins



June 2015

Package Code: F2



Internal Circuit Diagram

Package Marking and Ordering Information

Device	Device Marking	Package	Packing Type	Quantity / Tray
FPF2C8P2NL07A	FPF2C8P2NL07A	F2	Tray	14

Symbol	Descr	iption	Rating	Units
Outer IGBT	(Q1, Q4, Q5, Q8, Q9, Q12)			
V _{CES}	Collector-Emitter Voltage		650	V
V _{GES}	Gate-Emitter Voltage		± 20	V
I _C	Continuous Collector Current	@ T _C = 80 °C, T _{Jmax} = 175 °C	30	A
I _{CM}	Pulsed Collector Current	limited by T _{Jmax}	60	A
P _D	Maximum Power Dissipation	@ T _C = 25 °C	135	W
TJ	Operating Junction Temperature		- 40 to + 150	°C
Inner IGBT	(Q2, Q3, Q6, Q7, Q10, Q11)			•
V _{CES}	Collector-Emitter Voltage		650	V
V _{GES}	Gate-Emitter Voltage		± 20	V
I _C	Continuous Collector Current	@ T _C = 80 °C, T _{Jmax} = 175 °C	50	A
I _{CM}	Pulsed Collector Current	limited by T _{Jmax}	100	A
P _D	Maximum Power Dissipation	@ T _C = 25 °C	174	W
TJ	Operating Junction Temperature		- 40 to + 150	°C
Outer - Inne	er IGBT Series Connection			
SCWT	Short Circuit Withstand Time	V_{DC} = 300 V, V_{GE} = 15 V T _C = 25 °C	4	μS
Diode				
V _{RRM}	Peak Repetitive Reverse Voltage		650	V
I _F	Continuous Forward Current	@ T _C = 80 °C, T _{Jmax} = 175 °C	15	A
I _{FM}	Maximum Forward Current		30	A
P _D	Maximum Power Dissipation	@ T _C = 25 °C	100	W
TJ	Operating Junction Temperature		- 40 to + 150	°C
Module				
T _{STG}	Storage Temperature		- 40 to + 125	°C
V _{ISO}	Isolation Voltage	@ AC 1 min.	2500	V
IsoMaterial	Internal Isolation Material		Al ₂ O ₃	
T _{MOUNT}	Mounting Torque		2.0 to 5.0	Nm
Creepage	Terminal to Heat Sink		11.5	mm
	Terminal to Terminal		6.3	mm
Clearance	Terminal to Heat Sink		10.0	mm
	Terminal to Terminal		5.0	mm

2

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Outer IGE	р ЭТ	-	ļ			
Off Charac	teristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	650	-	-	V
I _{CES}	Collector Cut-off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	Gate-Emitter Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	2	μΑ
On Charac						•
V _{GE(th)}	Gate-Emitter Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 30 \text{ mA}$	4.5	5.6	6.7	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 30 A, V _{GE} = 15 V	-	1.55	2.2	V
()	-	$I_{C} = 30 \text{ A}, V_{GE} = 15 \text{ V} @T_{C} = 125 \text{ °C}$	-	1.75	-	V
		I _C = 60 A, V _{GE} = 15 V	-	2.13	-	V
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V	-	33	-	ns
t _r	Rise Time	$I_{\rm C} = 30 {\rm A}$	-	43	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{GE} = ± 15 V R _G = 20 Ω	-	197	-	ns
t _f	Fall Time	Inductive Load	-	17	-	ns
E _{ON}	Turn-On Switching Loss per Pulse	T _C = 25 °C	-	0.68	-	mJ
E _{OFF}	Turn-Off Switching Loss per Pulse		-	0.38	-	mJ
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V	-	29	-	ns
t _r	Rise Time	$I_{\rm C} = 30 {\rm A}$	-	50	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{GE} = ± 15 V R _G = 20 Ω	-	205	-	ns
t _f	Fall Time	Inductive Load	-	25	-	ns
E _{ON}	Turn-On Switching Loss per Pulse	T _C = 125 °C	-	0.86	-	mJ
E _{OFF}	Turn-Off Switching Loss per Pulse		-	0.52	-	mJ
Q _g	Total Gate Charge	V_{CC} = 300 V, I _C = 30 A, V _{GE} = ± 15 V	-	0.26	-	μC
R _{0JC}	Thermal Resistance of Junction to Case	per Chip	-	-	1.11	°C/W
Inner IGB	Т					
Off Charac						
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0 V, I_{C} = 1 mA$	650	-	_	V
I _{CES}	Collector Cut-off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μΑ
I _{GES}	Gate-Emitter Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	2	μΑ
On Charac		VGE VGES, VCE VV			2	μι
	Gate-Emitter Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 50$ mA	4.5	5.6	6.7	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_{\rm C} = 50 \text{ A}, V_{\rm GE} = 15 \text{ V}$	-	1.65	2.3	v
or(sar)	in the second	$I_{\rm C} = 50 \text{ A}, V_{\rm GE} = 15 \text{ V} @T_{\rm C} = 125 ^{\circ}\text{C}$	-	1.95	-	V
		$I_{\rm C} = 100 \text{ A}, V_{\rm GE} = 15 \text{ V}$	-	2.49	-	V
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V	-	41	-	ns
t _r	Rise Time	I _C = 50 A	-	65	-	ns
t _{d(off)}	Turn-Off Delay Time	$-V_{GE} = \pm 15 V$	-	233	-	ns
t _f	Fall Time	$R_{G} = 15 \Omega$ Inductive Load	-	18	-	ns
E _{ON}	Turn-On Switching Loss per Pulse	$T_{\rm C} = 25 ^{\circ}{\rm C}$	-	0.87	-	mJ
E _{OFF}	Turn-Off Switching Loss per Pulse		-	0.77	-	mJ
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V	-	39	-	ns
t _r	Rise Time	I _C = 50 A	-	76	-	ns
t _{d(off)}	Turn-Off Delay Time	$-V_{GE} = \pm 15 V$	-	243	-	ns
t _f	Fall Time	R _G = 15 Ω Inductive Load	-	20	-	ns
E _{ON}	Turn-On Switching Loss per Pulse	$T_{\rm C}$ = 125 °C	-	0.99	-	mJ
E _{OFF}	Turn-Off Switching Loss per Pulse		-	0.93	-	mJ
Q _g	Total Gate Charge	V _{CC} = 300 V, I _C = 50 A, V _{GE} = ± 15 V	-	0.39	-	nC
- ` Y	Thermal Resistance of Junction to Case	per Chip	-	-	0.86	°C/W

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Diode			I			
V _{FM}	Diode Forward Voltage	I _F = 15 A	-	2.55	3.4	V
		I _F = 15 A @T _C = 125 °C	-	1.78	-	V
I _R	Reverse Leakage Current	V _R = 650 V	-	-	250	μA
t _{rr}	Reverse Recovery Time	$V_{R} = 300 V, I_{F} = 15 A$ $di_{F} / dt = 700 A/us$ $T_{C} = 25 °C$	-	23	-	ns
l _{rr}	Reverse Recovery Current		-	9.9	-	Α
Q _{rr}	Reverse Recovery Charge		-	113	-	nC
t _{rr}	Reverse Recovery Time	$V_R = 300 \text{ V}, I_F = 15 \text{ A}$ di _F / dt = 700 A/us	-	49	-	ns
l _{rr}	Reverse Recovery Current		-	15.2	-	Α
Q _{rr}	Reverse Recovery Charge	– T _C = 125 °C	-	366	-	nC
R _{0JC}	Thermal Resistance of Junction to Case	per Chip	-	-	1.44	°C/W
NTC_The	ermistor					
R _{NTC}	Rated Resistance	T _C = 25 °C	-	5.0	-	kΩ
		T _C = 100 °C	-	493	-	Ω
	Tolerance	T _C = 25 °C	- 5	-	+ 5	%
PD	Power Dissipation	T _C = 25 °C	-	-	20	mW
B _{Value}	B-Constant	B _{25/50}	-	3375	-	К
		B _{25/100}	-	3436	-	К



Tc = 125 °C

E

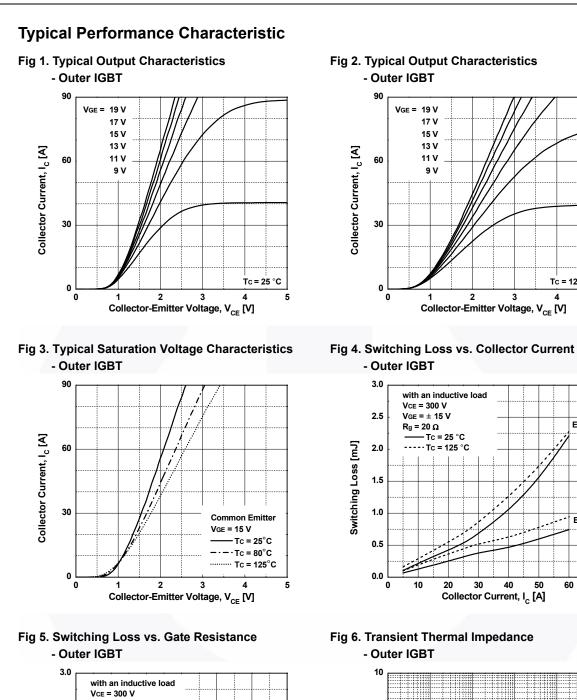
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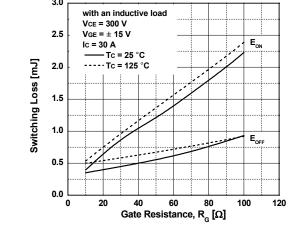
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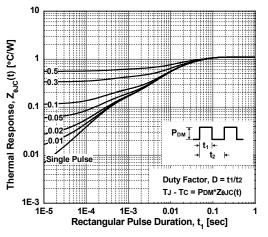
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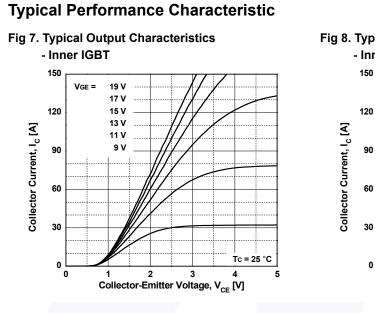
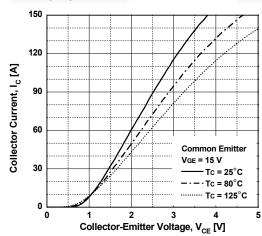
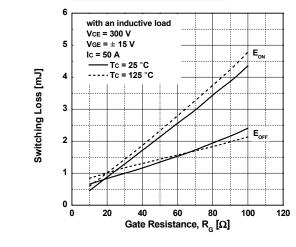
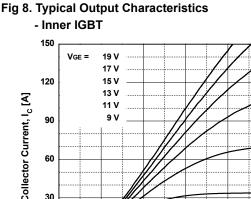


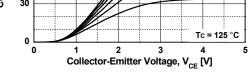
Fig 9. Typical Saturation Voltage Characteristics - Inner IGBT

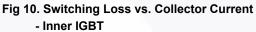


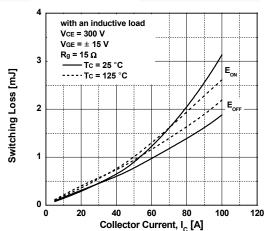


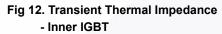


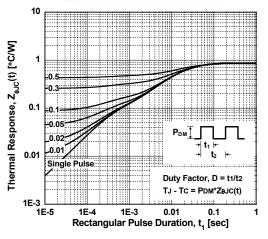


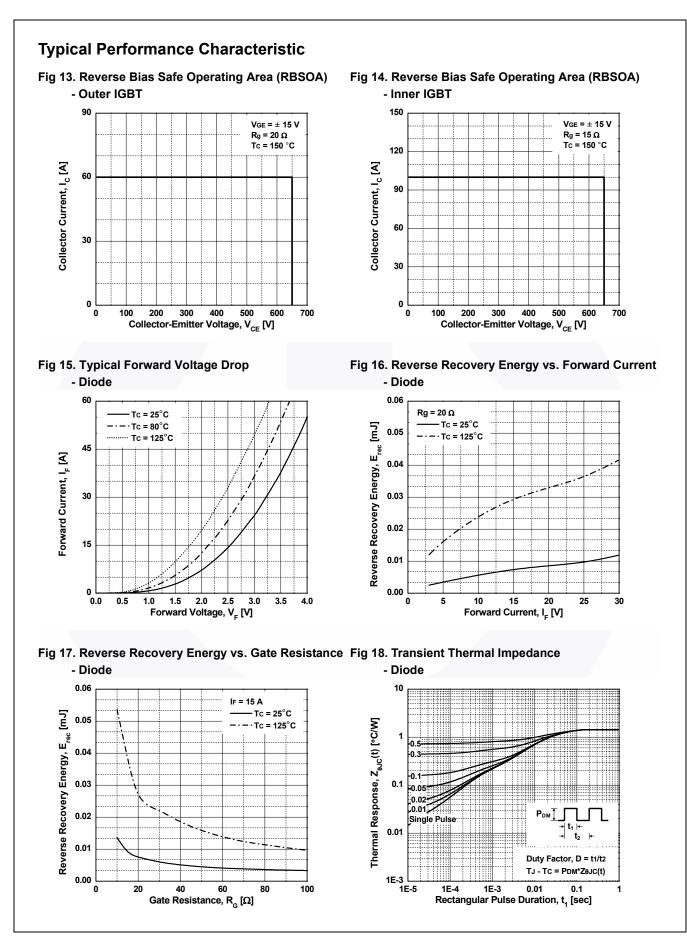




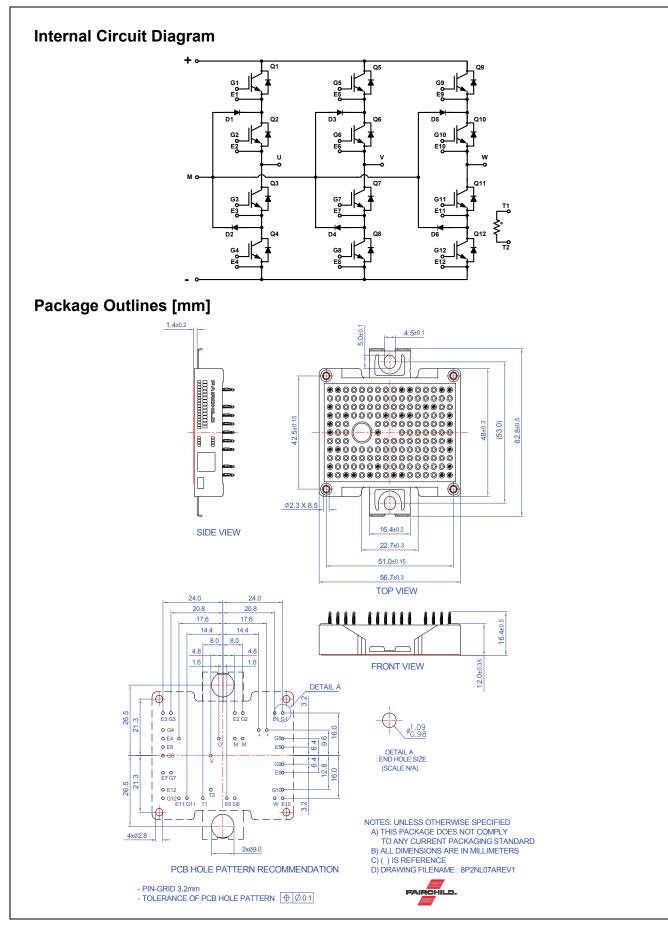


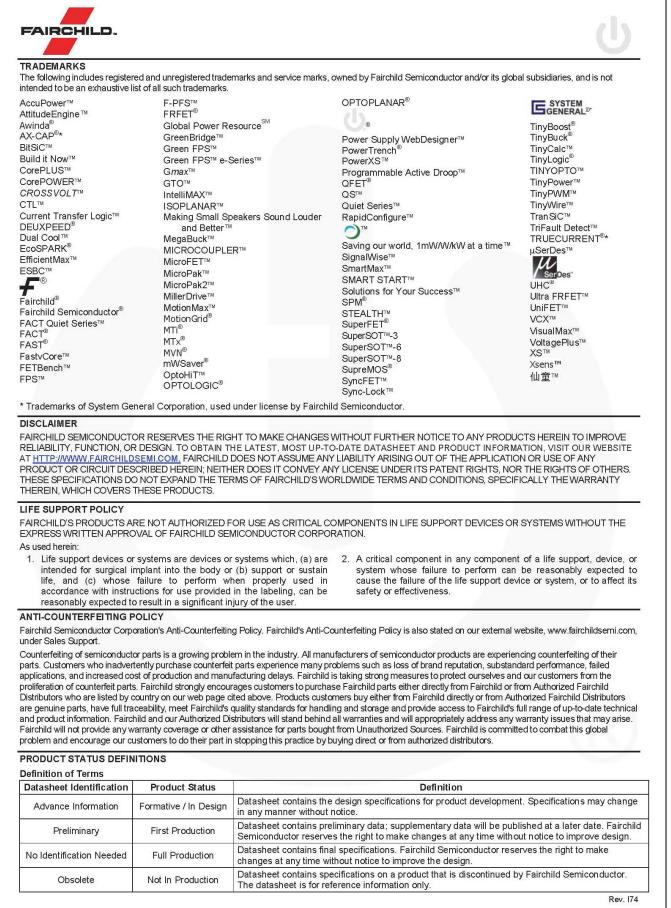






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